
High-performance digital Unipolar Hall switch IC

1. Features

- Automotive AEC-Q100 Qualified
- Unipolar Hall sensor
- Multiple sensitivity ranges available
- High chopping frequency
- Supports a wide voltage range:
 - 2.5V to 24V
- Reverse battery protection: -28V
- Wide operating temperature range:
 - -40°C to 150°C
- Over-voltage protection at all pins
- Small package
 - 3-pin SOT23-3L (SO)

2. Applications

- Gear shift selectors
- Open/close sensor for LCD screens/doors/lids/trunks
- Clutch/brake position sensor
- Wiper home/end position sensor
- End-of-travel and index sensor

3. Description

The SC243X family, produced with Bi-CMOS technology, is a chopper-stabilized Hall Effect Sensor that offers a magnetic sensing solution with superior sensitivity stability over temperature and integrated protection features. Superior high-temperature performance is made possible through dynamic offset cancellation, which reduces the residual offset voltage normally caused by device over molding, temperature dependencies, and thermal stress. Each device includes a voltage regulator, Hall-voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, and an open-drain output to sink up to 20mA.

SC243X An onboard regulator permits with supply voltages of 2.5 to 24V which makes the device suitable for a wide range of industrial and automotive applications

SC243X uses a 3-pin SOT23-3L package (SO). 100% lead-free matte tin-plated lead package.



SOT23-3L

Fig.1 Package Outline

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4. Terminal Configuration

3-Terminal SOT-23
SO Package
(Top View)

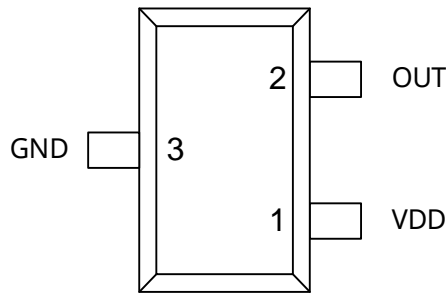


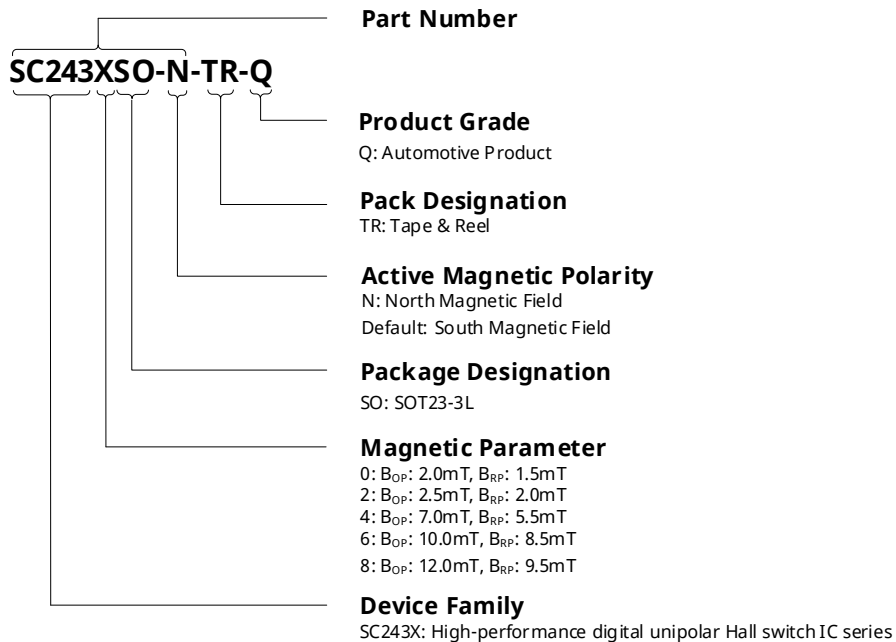
Fig.2 Terminal Configuration

Terminal		Type	Description
Name	SO		
VDD	1	Power	2.5V to 24V power supply
GND	3	Ground	Ground terminal
OUT	2	Output	Open-drain output. The open drain requires a pull-up resistor

5. Ordering Information

Ordering Information	Mark	Option	B _{OP} (mT)	B _{RP} (mT)	Ambient, T _A (°C)	Package	Packing	Quantity
SC2430SO-TR-Q	2430	South	2.0	1.5	-40~150	SOT23-3L	Reel	3000/reel
SC2432SO-TR-Q	2432	South	2.5	2.0	-40~150	SOT23-3L	Reel	3000/reel
SC2432SO-N-TR-Q	2432	North	-2.5	2.0	-40~150	SOT23-3L	Reel	3000/reel
SC2434SO-TR-Q	2434	South	7.0	5.5	-40~150	SOT23-3L	Reel	3000/reel
SC2434SO-N-TR-Q	2434	North	-7.0	-5.5	-40~150	SOT23-3L	Reel	3000/reel
SC2436SO-TR-Q	2436	South	10.0	8.5	-40~150	SOT23-3L	Reel	3000/reel
SC2438SO-TR-Q	2438	South	12.0	9.5	-40~150	SOT23-3L	Reel	3000/reel

Ordering Information Format



6. Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

Symbol	Parameter	Test Condition	Min.	Max.	Units
V _{DD}	Power supply voltage		-28	28	V
V _{OUT}	Output terminal voltage	For 5 Min. @1.2K pull-up resistor	-0.5	28	V
I _{SINK}	Output terminal current sink		0	30	mA
T _A	Operating ambient temperature		-40	150	°C
T _J	Maximum junction temperature		-55	165	°C
T _{STG}	Storage temperature		-65	175	°C

Note:

(1) Stresses above those listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

7. ESD Protection

Symbol	Parameter	Test Condition	Min.	Max.	Units
V _{ESD_HBM}	HBM	According to: standard AEC-Q100-002 HBM	-4	+4	kV
V _{ESD_CDM}	CDM	According to: standard AEC-Q100-011 CDM	-750	+750	V

8. Thermal Characteristics

Symbol	Parameter	Test Conditions	Rating	Units
R _{θJA}	SO Package thermal resistance	Single-layer PCBS, JEDEC 1s0p are defined in JESD 51-3	300 ⁽¹⁾	°C/W

Note:

(1) Maximum voltage must be adjusted for power dissipation and junction temperature, see Thermal Characteristics.

9. Operating Characteristics

9.1. Electrical Characteristics

Over operating free-air temperature range $V_{DD} = 5.0V$ (unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ. ⁽¹⁾	Max.	Units
V_{DD}	Operating voltage ⁽²⁾	$T_J < T_{J(Max.)}$	2.5	5.0	24	V
I_{DD}	Operating supply current	$V_{DD}=2.5$ to 24 V, $T_A=25^\circ C$	1.0	1.6	2.5	mA
t_{on}	Power-on time		-	35	50	μs
I_{QL}	Off-state leakage current	Output Hi-Z	-	-	1	μA
$R_{DS(on)}$	FET on-resistance	$V_{DD}=5.0V$, $I_O=10mA$, $T_A=25^\circ C$	-	20	-	Ω
		$V_{DD}=5.0V$, $I_O=10mA$, $T_A=125^\circ C$	-	30	-	Ω
t_d	Output delay time	$B=B_{RP}$ to B_{OP}	-	15	25	μs
t_r	Output rise time (10% to 90%)	$R_1=1k\Omega$, $C_o=50pF$	-	0.2	0.5	μs
t_f	Output fall time (90% to 10%)	$R_1=1k\Omega$, $C_o=50pF$	-	0.1	0.2	μs

Note:

(1) Typical values are defined at $T_A=25^\circ C$ and $V_{DD}=5.0V$

(2) Maximum voltage must be adjusted for power dissipation and junction temperature, see Thermal Characteristics

9.2. Magnetic Characteristics

Over operating free-air temperature range, $V_{DD} = 5.0V$ (unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
f_{BW}	BW		20	-	-	kHz
SC2430 2.0⁽¹⁾/1.5mT⁽²⁾						
B_{OP}	Operating point	$T_A=25^\circ C$	1.5	2.0	3.5	mT
B_{RP}	Release point		1.0	1.5	2.0	mT
B_{HYS}	Hysteresis		-	0.5	-	mT
SC2432 2.5 /2.0 mT						
B_{OP}	Operating point	$T_A=25^\circ C$	1.5	2.5	3.5	mT
B_{RP}	Release point		1.0	2.0	3.0	mT
B_{HYS}	Hysteresis		-	0.5	-	mT
SC2434 7.0 /5.5 mT						
B_{OP}	Operating point	$T_A=25^\circ C$	6.0	7.0	8.0	mT
B_{RP}	Release point		4.5	5.5	6.5	mT
B_{HYS}	Hysteresis		-	1.5	-	mT
SC2436 10.0 /8.5 mT						
B_{OP}	Operating point	$T_A=25^\circ C$	9.5	10.0	10.5	mT
B_{RP}	Release point		8.0	8.5	9.0	mT
B_{HYS}	Hysteresis		-	1.5	-	mT
SC2438 12.0 /9.5 mT						
B_{OP}	Operating point	$T_A=25^\circ C$	10.0	12.0	14.0	mT
B_{RP}	Release point		7.5	9.5	11.5	mT
B_{HYS}	Hysteresis		-	2.5	-	mT

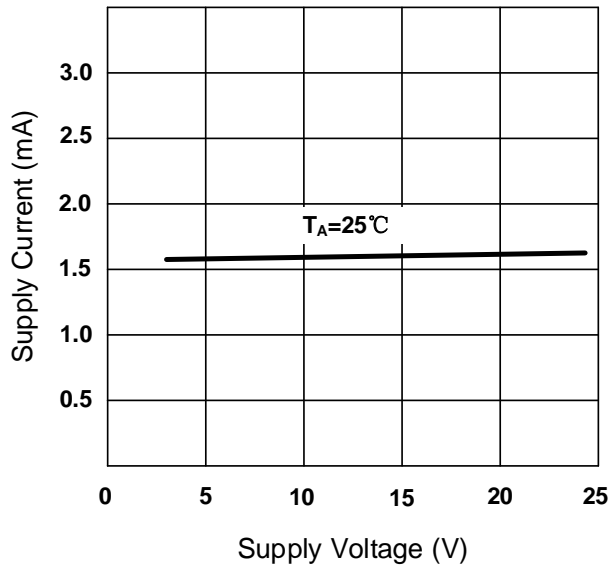
Note:

(1) Magnetic flux density, B is indicated as a negative value for North-polarity magnetic fields, and as a positive value for South-polarity magnetic fields,

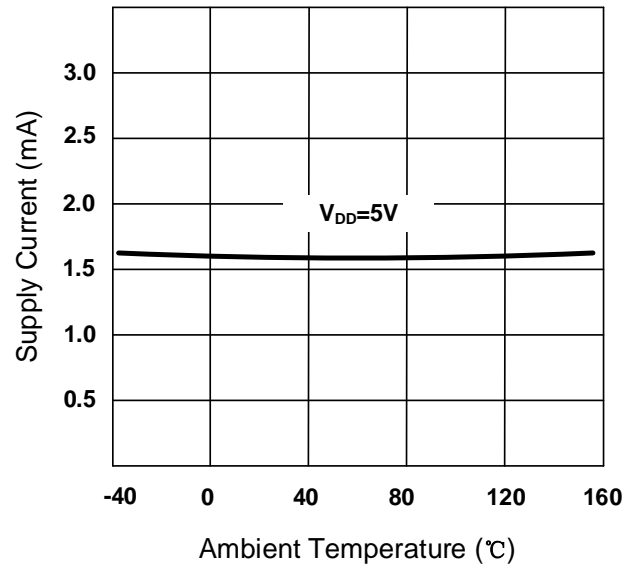
(2) $1mT=10Gs$

10. Typical Characteristics

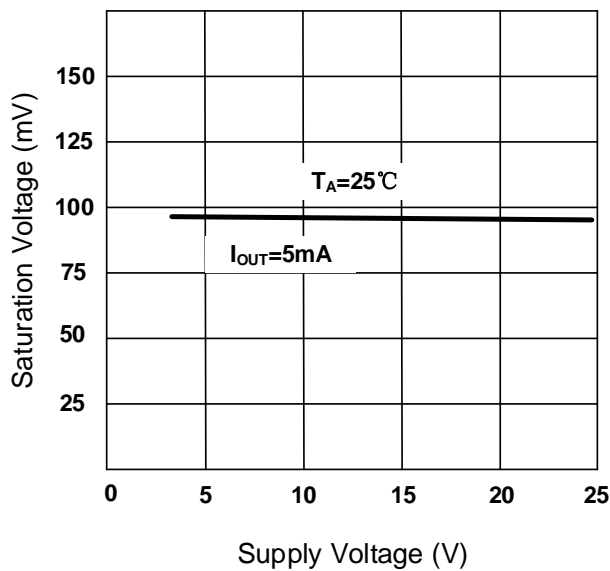
I_{DD} vs V_{DD}



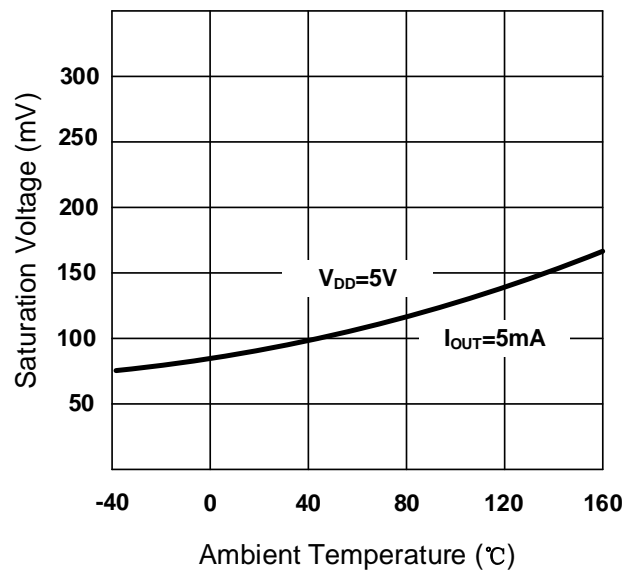
I_{DD} vs T_A



$V_{Q(sat)}$ vs V_{DD}



$V_{Q(sat)}$ vs T_A



11. Block Diagram

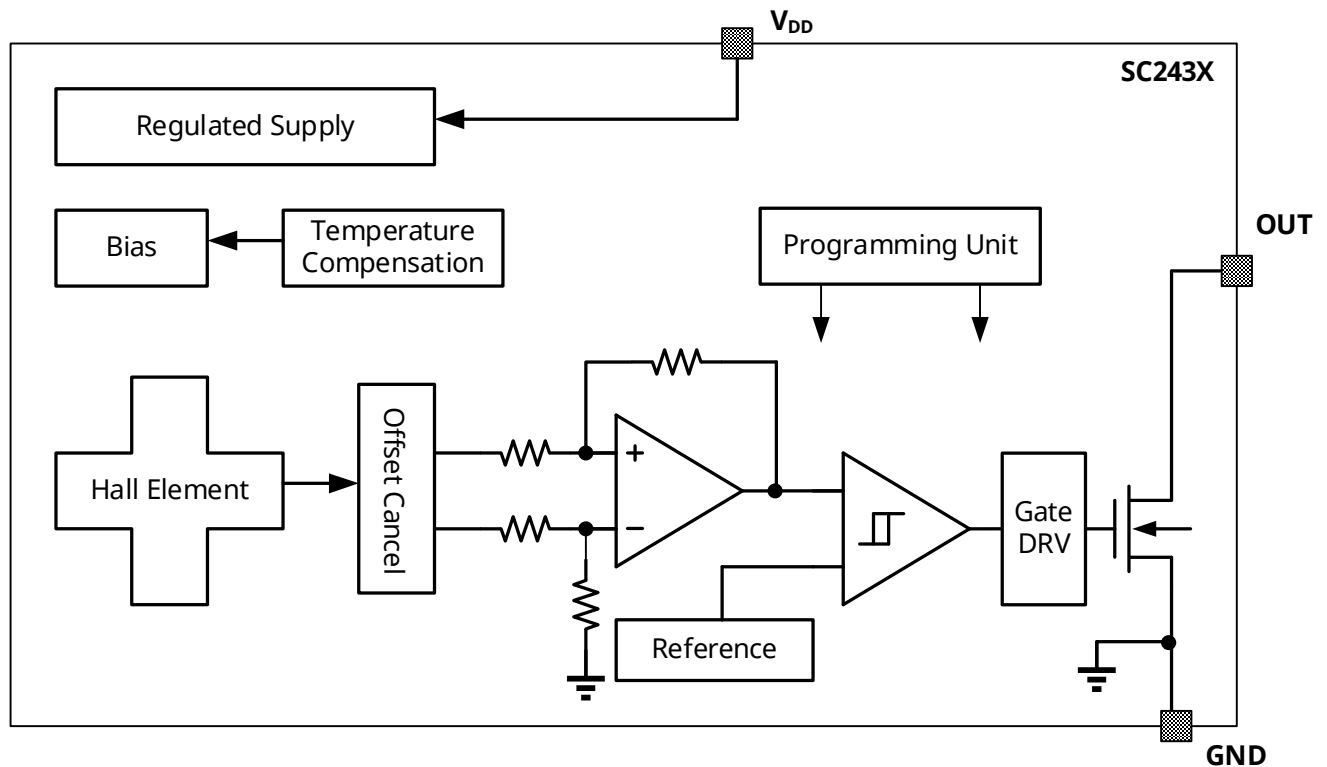


Fig.3 Function Block Diagram

12. Function Description

SC243X is a unipolar Hall effect sensor. With the application of chopper technology, the chip has a stable switching point and is mainly used in magnetic induction applications. It can work normally under a voltage range of 2.5V to 24V and will not be damaged under a reverse connection of -28V.

The SC243X outputs a low level (turns on) when a magnetic field perpendicular to the Hall element increases to the operating point B_{OP} . In the on state, the output can sink a current of 20mA, and the output voltage is $V_{Q(SAT)}$. When the magnetic field weakens to the release point B_{RP} , it outputs a high level (turns off). The difference between the magnetic field's turn-on point and turn-off point is the hysteresis of the switching point. This built-in hysteresis enables the chip to work normally under external mechanical interference and noise.

An external output pull-up resistor is required on the OUT terminal. The OUT terminal can be pulled up to V_{DD} or to a different voltage supply. It is convenient to interface with the controller.

12.1. Magnetic Field Direction Definition

A positive magnetic field is defined as a South pole near the marked side of the package.

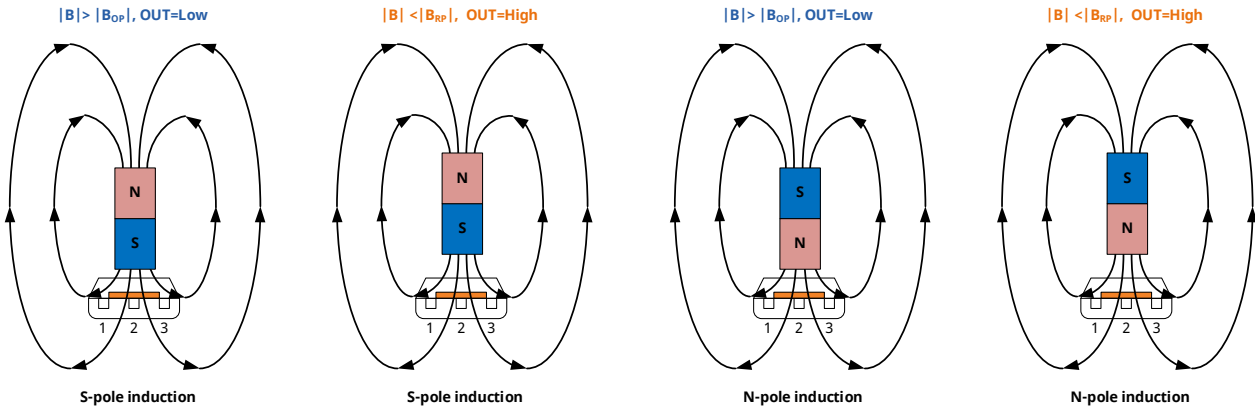


Fig.4 Magnetic Field Direction Definition

12.2. Transfer Function

Powering-on the device in the hysteresis region, less than B_{OP} and higher than B_{RP} , allows an indeterminate output state. The correct state is attained after the first excursion beyond B_{OP} or B_{RP} . If the field strength is greater than B_{OP} , then the output is pulled low. If the field strength is less than B_{RP} , the output is released.

B_{OP} —magnetic threshold for activation of the device output, turning in ON (low) state

B_{RP} —magnetic threshold for release of the device output, turning in OFF (high) state.

$$B_{HYS} = B_{OP} - B_{RP}$$

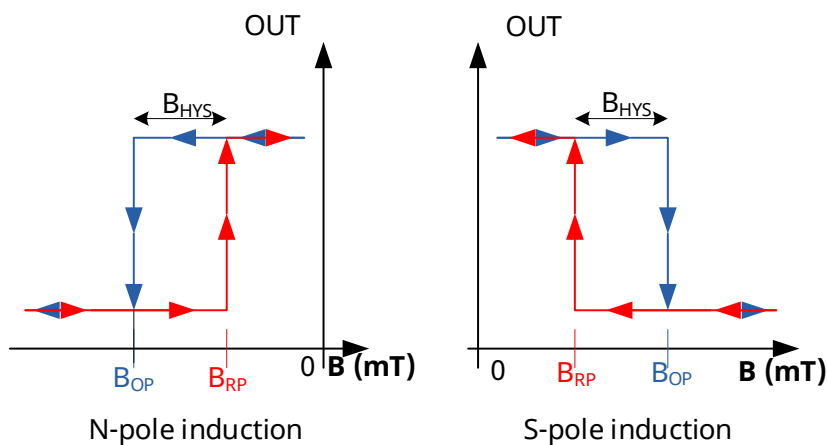


Fig.5 Magnetic Transfer Function

13. Typical Application

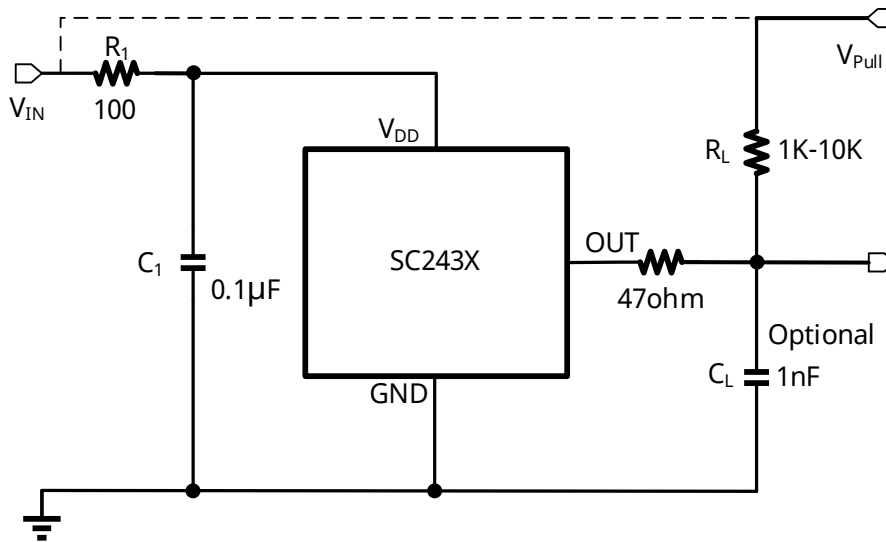


Fig.6 Typical Application Circuit

The SC243X contains an on-chip voltage regulator and can operate over a wide supply voltage range. In applications that operate the device from an unregulated power supply, transient protection must be added externally. For applications using a regulated line, EMI/RFI protection may still be required. It is recommended to shunt C_1 capacitors to the ground near the chip V_{DD} power supply, with a typical value of $0.1\mu\text{F}$. At the same time in the external optional series resistor R_1 their typical values for 100Ω . The output capacitor C_L is used as the output filter, typically 1nF .

The output stage of the SC243X device is a drain open-circuit NMOS tube, which provides a load capacity of 20mA . Adjust the pull-up resistor R_L to make it work properly. The R_L provides a high level for the leak-opening output. In general, less current is better, but faster transient response and bandwidth are required, with a smaller resistor R_L for faster switching.

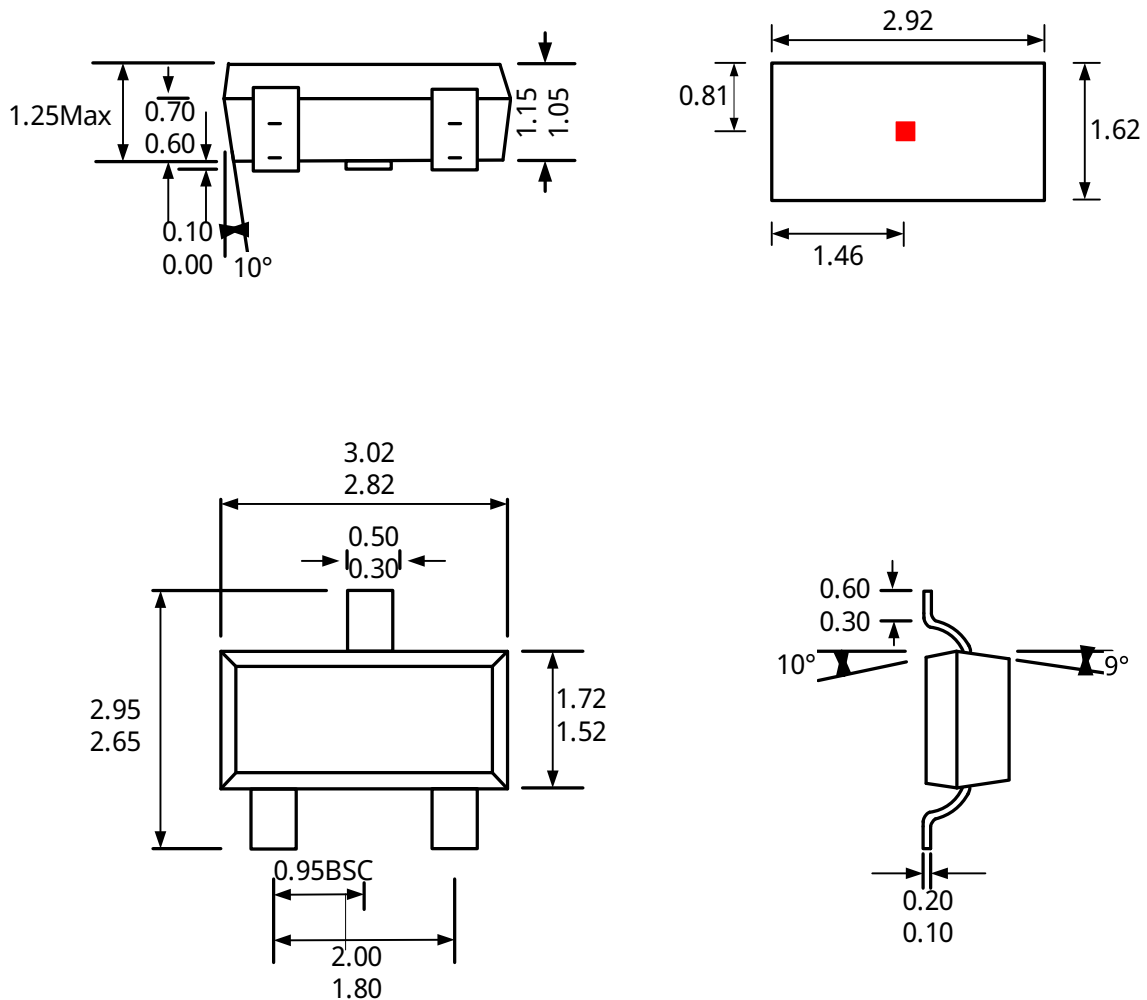
Select a value for C_L based on the system bandwidth specifications such as:

$$C_L < \frac{1}{2\pi \times R_L \times 2 \times f_{BW}(\text{Hz})}$$

V_{PULL} is not restricted to V_{DD} and could be connected to other voltage power supply. The allowable voltage range of this terminal is specified in the Absolute Maximum Ratings.

14. Package Information SO

SOT23-3L Package Outline Dimensions



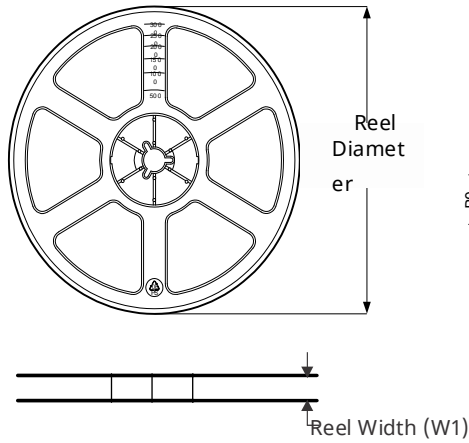
Notes:

- (1) All unit in mm.
- (2) Dimension does not include mold flash, protrusions or gate burrs.
- (3) Allowable dambar protrusion shall be in excess at maximum material condition.

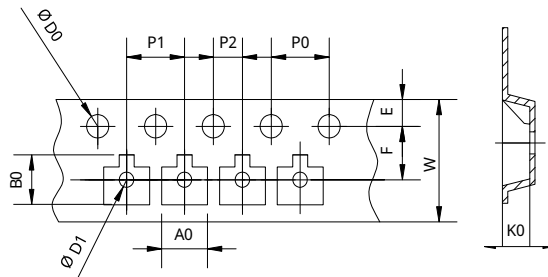
If no tolerance is specified, the dimension shall be theoretical reference value and shall not represent the exact dimension for actual measurement.

15. Tape&Reel Information

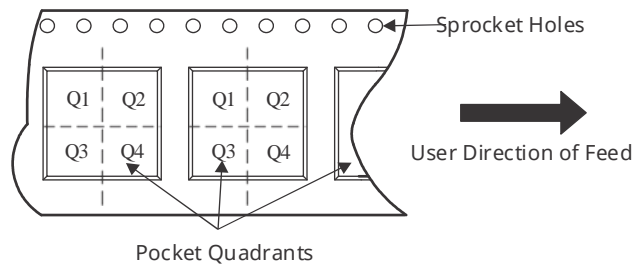
TAPE REEL DIMENSIONS



TAPE DIMENSIONS



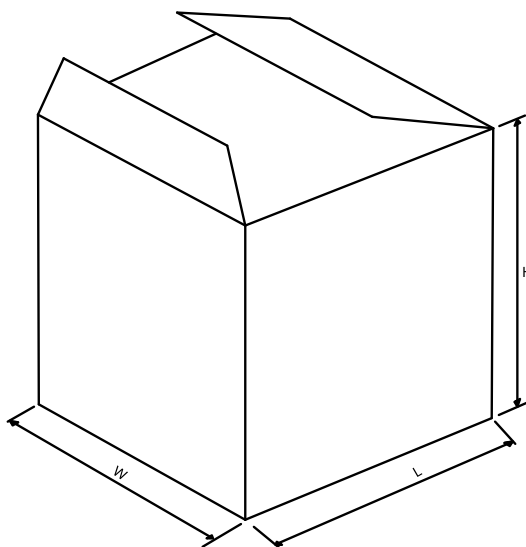
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Package Type	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	W (mm)	Pin1 Quadrant
SOT-23-3L	3000	180	8.4	4.00	2.00	4.00	3.18	3.28	1.32	8.00	Q3

16. Tape&Reel Box Dimensions



*All dimensions are nominal

Package Type	SPQ	Length (mm)	Width (mm)	Height (mm)
SOT-23-3L	3000ea*10tape	210	210	210

17. Revision History

Revision	Date	Description
Rev.1.0	2016-05-10	Preliminary datasheet
Rev.1.1	2017-08-06	Add order information of SC2438SO
Rev.1.3	2019-05-06	The final revision of old datasheet
Rev.A1.0	2021-01-04	Unified datasheet format
Rev.A1.1	2024-05-06	Update part number in order information
Rev.A1.2	2024-07-19	Correct SC2438 magnetic parameter
Rev.A1.3	2024-11-28	Update ordering information, update TO-92S package dimension
Rev.A1.4	2025-08-06	Unify the format of automotive product specifications
Rev.A1.5	2026-04-01	Add packaging information and declarations

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